

WHAT IS CLAIMED IS:

1. An embossing system, comprising:
 - a sleeve having a first part and a second part;
 - a stencil being adapted to be positioned between the sleeve first part and sleeve second part; and
 - a form being adapted to be positioned between the stencil and either the sleeve first part or sleeve second part.
2. The embossing system of claim 1, wherein the embossing system is adapted to accept embossing material between the form and the stencil.
3. The embossing system of claim 1, wherein an adhesive is disposed between the form and the sleeve first part or the sleeve second part to hold the form stationary relative to the sleeve.
4. The embossing system of claim 3, wherein static vinyl is disposed between the form and the sleeve first part or the sleeve second part to hold the form stationary relative to the sleeve.
5. The embossing system of claim 1, wherein an adhesive holds the stencil in place against the sleeve first part or the sleeve second part.
6. The embossing system of claim 1, wherein the stencil is made of a metallic material.
7. The embossing system of claim 1, wherein the form is made of a plastic material.
8. The embossing system of claim 1, wherein the sleeve first part and the sleeve second part are connected by a hinge.
9. An embossing system, comprising:
 - a force transfer assembly comprising:

a first cover, an opposite second cover; and
a hinge connecting said first cover and said second cover; and
said force transfer assembly further comprising a stencil and an opposing
form positioned internal of the force transfer assembly, said stencil and said form being
adapted to sandwich an embossing material between said stencil and said form.

10. The embossing system of claim 9, wherein a layer of static vinyl is located
between one of the covers to secure the form to one of the covers.

11. The embossing system of claim 10, wherein an adhesive is located on the
cover opposite the cover with the vinyl to secure the stencil.

12. The embossing system of claim 9, wherein when the force transfer
assembly is in a closed position, there is a clearance between the form and the stencil.

13. The embossing system of claim 9, wherein the force transfer assembly
includes at least two apertures so that the force transfer assembly is adapted to be located
on pins located on a die press.

14. The embossing system of claim 9, wherein the hinge means comprises a
plastic material.

15. The embossing system of claim 9, wherein the hinge means is an adhesive
film material.

16. The embossing system of claim 15, wherein the adhesive film material is a
tape material.

17. The embossing system of claim 12, wherein the hinge is a reduced
thickness area joining the first cover and the opposite second cover.

18. The embossing system of claim 17, wherein the first cover, the second cover, and the hinge are made from a continuous sheet of material.
19. The embossing system of claim 18, wherein the hinge is made of a clear material.
20. The embossing system of claim 17, wherein the hinge provides for the clearance between the form and the stencil when the embossing system is operated.
21. The embossing system of claim 20, wherein the clearance is at least .1 millimeter.
22. The method for embossing and embossing material, comprising the steps of:

providing a force transfer assembly, which includes a first cover, an opposition second cover, and a hinge for connecting the first cover and the second cover;

providing a stencil and an opposing form that is adapted to be positioned internal of the force transfer assembly, the stencil and the form being adapted to sandwich an embossing material between the stencil and the form.